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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/573,539	03/27/2006	Henryk Frenzel	2003P12502	7154		
	7590 09/19/200 E NBERG STEMER LI	EXAMINER				
POBOX 2480		CHIEM, DINH D				
HOLL I WOOL	o, FL 33022-2480		ART UNIT	PAPER NUMBER		
			2883			
		MAIL DATE	DELIVERY MODE			
			09/19/2008	PAPER		

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Office Action Communication		Application	pplication No. Applicant(s)						
		10/573,539	1	FRENZEL, HENRYK					
Office Action Summary			Examiner		Art Unit				
			ERIN D. CH	IIEM	2883				
Period fo	The MAILING DATE of this commun or Reply	ication appe	ears on the	cover sheet with the c	orrespondence ad	ddress			
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).									
Status									
1) 又	Responsive to communication(s) file	ed on <i>15 Au</i>	naust 2008						
,	•	2b)⊠ This a		n-final					
3)		<i>,</i> —			secution as to the	e merits is			
٠,١	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.								
	·	100 di 140i 27	r parto qua	y,o, 1000 C.D. 11, 10	.0 0.0.210.				
Dispositi	on of Claims								
4)🛛)⊠ Claim(s) <u>14-21 and 23-33</u> is/are pending in the application.								
	4a) Of the above claim(s) is/are withdrawn from consideration.								
5)	5) Claim(s) is/are allowed.								
6)⊠	6)⊠ Claim(s) <u>14-21 and 23-33</u> is/are rejected.								
7)	Claim(s) is/are objected to.								
8)□	Claim(s) are subject to restrict	ction and/or	election red	quirement.					
Applicati	on Papers								
9)	The specification is objected to by th	e Examiner							
10)	The drawing(s) filed on is/are:	: a) <u></u> acce	pted or b)	objected to by the B	Examiner.				
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
						FR 1.121(d).			
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.									
Priority ι	ınder 35 U.S.C. § 119								
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 									
2) Notic 3) Inform	t(s) e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (F nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	PTO-948)		4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	nte				

DETAILED ACTION

This office action is in response to applicant's submission of the Request for Continued Examination on August 15, 2008. Currently, claims 14-21 and 23-33. The amendment to claim 14 overcame the 102 rejection of Yamada and new ground(s) of rejection in view of Yamada and Shinomiya.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 14-19, 21, 23-33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamada et al. (US 2001/0050717 A1) in view of Shinomiya (DE-10221892-A1).

Regarding claim 14, 32-33 Yamada discloses an optical module comprising: a circuit carrier (5), a non-packaged semiconductor device flip-chip mounted (Para [0042]) on said circuit carrier, a lens unit (2) disposed for projecting electromagnetic radiation onto said semiconductor device, said lens unit including a lens holder and a lens assembly with at least one lens (3), and said circuit carrier having at least one relatively thin region and a relatively thick region supporting said thin region ('21', '5'). The thin region and the thick region are implemented as a molded interconnect device with integrated conductor tracks (printed circuit board), wherein the thin region is a flexible circuit board and the thick region is a rigid printed circuit board (Para

[0041]-[0044]). The structures of the thin and thick region are present in the prior art. The limitations of a molded interconnect has been identified as a Product-by-Process limitation. The thick and thin regions are connected at junction [29]. How these regions are formed does not bare patentable weight because this is a device claim.

However, Yamada does not disclose the semiconductor device being disposed on an opposite side of said circuit carrier with respect to said lens holder and in said thin region of said circuit carrier.

Shinomiya discloses in Fig. 11 and 12 a solid state image pick up device wherein a semiconductor device is being disposed on an opposite side of said circuit carrier with respect to said lens holder and in said thin region of said circuit carrier. It would have been obvious to one having ordinary skill in the art to recognize the disclosure of Shinomiya would be understood and modifiable with the art of Yamada wherein the **motivation** to modify the art of Yamada is to increase mechanical bond between the lens holder and semiconductor with said circuit carrier.

Regarding claim 15, the lens holder is shown in Fig. 2 wherein the lens holder is *supported* in said thin region of said circuit carrier.

Regarding claims 24-29, examiner considers the screws formed in the layer labeled '21' of Fig. 3 to be support elements such that the support elements at least partially formed on said lens holder which is mounted on the circuit carrier, thus the circuit carrier forms a part of said lens unit..

Regarding claim 30, wherein the semiconductor device is disposed on a side of said circuit carrier facing *away* from said lens unit and the thin region of the circuit carrier is formed

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with an opening enabling through projection of electromagnetic radiation from said lens assembly onto said semiconductor device (See figs.9, 11, 12-15, and 18 for example).

Regarding claim 31, wherein the optical system comprising at least one optical module according to claim 14, see Fig. 20.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claim 20 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yamada and Shinomiya as applied to claim1 above, and further in view of Kothmeier (US 2003/0193609 A1). Yamada and Shinomiya do not explicitly disclose the circuit carrier thick region is a rigid portion of an FR4 circuit board. Kothmeier discloses an optical carrier and housing arrangement for receiving a color splitter system and several image converters utilizes an optical carrier comprising of a FR4 (flame resistance 4) circuit board. The motivation for utilizing FR4 circuit board is a convention in the art of electronics as disclosed by Kothmeier (Para [0016]).

Conclusion

Applicant's amendment to claim 14 overcame the rejection of Yamada and examiner provided new grounds of rejection.

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Any inquiry concerning this communication or earlier communications from the examiner should be directed to ERIN D. CHIEM whose telephone number is (571)272-3102. The examiner can normally be reached on Monday - Thursday 9AM - 5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Frank G. Font can be reached on (571) 272-2415. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Erin D Chiem/ Examiner, Art Unit 2883 /Frank G Font/ Supervisory Patent Examiner, Art Unit 2883